

QUALITEK® 393 NO CLEAN FLUX

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Description

Qualitek® 393 is a No Clean, Halogen-Free, organic-based flux with very low solids, designed for wave soldering, surface mount assembly or through-hole applications. 393 exhibits excellent wetting and fluxing activities and leaves virtually no residue on the assembly post-soldering. 393 may be used for both leaded and lead-free applications.

Main Features

- □ Halogen-free
- □ Low residue
- Excellent wetting
- □ Rosin/Resin free
- □ Compatible with Lead-Free & Leaded Solder Systems

Technical Data

	Specification	Test Method	
Flux Classification	ORL0	IPC-J-STD-004B	
Color and Appearance	Light straw liquid		
SIR	>1.0 x 10 ⁸ ohms	IPC-TM-650 2.6.3.3	
Specific Gravity (g/cm³)	0.811 ± 0.006		
Solids	2.9 ± 0.1	IPC-TM-650 2.3.34	
Acid Number (mgKOH/g)	22.0 – 25.0	IPC-TM-650 2.3.13	

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Applications

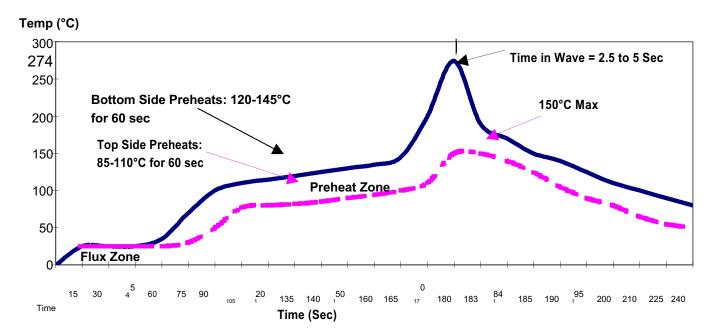
Flux Application

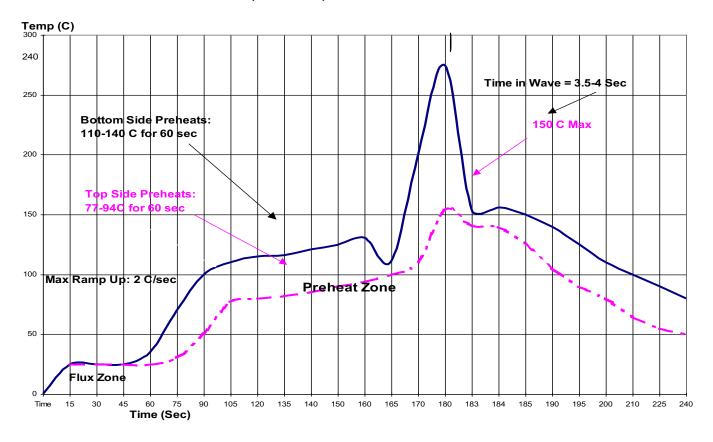
For wave soldering of OSP and plated circuit boards, spray, foam or wave fluxing can be utilized to apply this flux. Flux deposition density and uniformity are critical to successful use of low solids no-clean flux. If foam fluxing, the foam fluxer should be supplied with compressed air, which is free of oil and water. The flux tank should be full at all times. The surface of the flux should be 1-½ inches above the top of the flux aerator, or flux stone. Pressure should then be adjusted to produce the optimum foam height with a fine uniform foam head. After fluxing, an air knife should be used to remove excessive flux from the assembly.

Uniformity of the spray flux coating can be visually checked by running a tempered glass plate (usually supplied by machine manufacturer) through the spray and preheat sections, and inspected before going across the wave.

OPERATING PARAMETERS	TYPICAL LEVEL
Amount of flux	Foam, Wave: 1000-2000 μg/in ² solids
	Spray: 750-1500 μg/in ² solids
Foam Fluxing Parameters	
Foam Stone Pore Size	20-50 μm
Flux Level Above Stone	1-1 ½ inches (25-40mm)
Chimney Opening	3/8-1/2 inch (10-13 mm)
Air Pressure	1-2 psi
Top Side Preheat Temperature	190-230 °F (85-110 °C)
Bottom Side Preheat Temperature	65 °F (35 °C) higher than topside
Conveyor Speed	4-6 feet/minute(1.2-1.8 meters/minute)
Contact Time in the Solder (including Chip & Lambda)	2.5-4.5 seconds
Solder Pot Temperature	
	500-530 °F (260-276 °C)
	536-565 °F (280-296 °C)
	510-530 °F (265-276 °C)
SnAgCu	520-530 °F (271-276 °C)
Sn95/Sb5	536-565 °F (280-296 °C)

TYPICAL Lead Free Wave Solder Profile (SNAGCU)





TYPICAL Leaded Wave Solder Profile (Sn63/Pb37)

Process Control

Control of flux during use is necessary to assure consistent flux deposition on the circuit board. Due to the very low solids content of no clean fluxes, specific gravity is not an accurate measure for assessing solids content. Monitoring and controlling acid number by titration is recommended for maintaining the proper flux concentration. Control of the flux can be achieved with 300A thinner to maintain fluxing activity.

Over time debris and contaminants may accumulate in the flux reservoir. Therefore, periodically replacing the flux and cleaning the reservoir is recommended for consistent performance and minimizing debris build-up.

Cleaning

393 is a No Clean formulation therefore the residues do not need to be removed for typical applications. If residue removal is desired, the use of Everkleen 1005 Buffered Saponifier with a 5-15% concentration in hot 60 °C (140 °F) will aid in residue removal.

Storage & Shelf Life

Liquid flux should be stored in a cool, dry environment away from direct heat and flame. Shelf life is 2 years from date of manufacture.

Packaging

393 No Clean Halogen-Free Flux is available in

1 Gallon/1 Liter containers 5 Gallon/5 Liter containers 55 Gallon/20 Liter containers

Disposal

393 contains hazardous ingredients, therefore, the flux should be disposed of in accordance with federal, state, and local authority requirements.

Qualitek® is a brand of Qualitek International, Inc.